

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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1A, 400V - 600V Surface Mount Rectifier

FEATURES

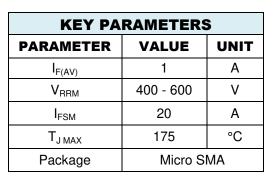
- AEC-Q101 qualified
- Ideal for automated placement
- Low forward voltage drop
- Glass passivated chip junction
- Moisture sensitivity level: level 1, per J-STD-020
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- Converter
- Free wheeling
- LED lighting
- Adapters

MECHANICAL DATA

- Case: Micro SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.006 g (approximately)











Micro SMA

PARAMETER	SYMBOL	S1GM	S1JM	UNIT
Marking code on the device		A5	A7	
Repetitive peak reverse voltage	V_{RRM}	400	600	V
Forward current	I _{F(AV)}	1		А
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I _{FSM}	20		А
Junction temperature	TJ	- 55 to +175		°C
Storage temperature	perature T _{STG}		- 55 to +175	

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Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP.	UNIT	
Junction-to-lead Thermal Resistance	$R_{\Theta JL}$	30	°C/W	
Junction-to-ambient thermal resistance	R_{\ThetaJA}	110	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Forward voltage per diode (1)	$I_F = 1A, T_J = 25^{\circ}C$	V _F	-	1.10	V
D	T _J = 25°C	I _R	-	1	μΑ
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 125°C		-	50	μΑ
Junction capacitance	1 MHz, V _R =4.0V	CJ	5	-	pF
Devices veces very time	I _F =0.5A ,I _R =1.0A	t _{rr}	780	-	ns
Reverse recovery time	$I_F=0.5A$, $I_R=1.0A$ $I_{RR}=0.25A$				

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION				
PART NO.	PACKAGE	PACKING		
S1GMHRSG	Micro SMA	3000 / 7" Plastic reel		
S1JMHRSG	Micro SMA	3000 / 7" Plastic reel		



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

1.2 AVERAGE FORWARD CURRENT (A) 1 8.0 0.6 0.4 0.2 **RESISTIVE OR** INDUCTIVE LOAD 0 0 25 50 75 100 125 150 175 LEAD TEMPERATURE (°C)

Fig.2 Typical Junction Capacitance

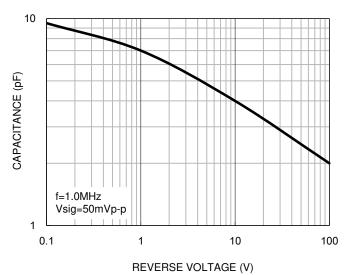


Fig.3 Typical Reverse Characteristics

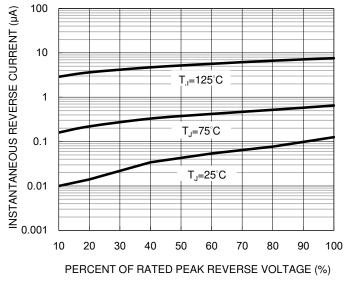
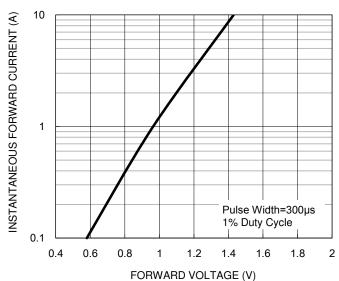


Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

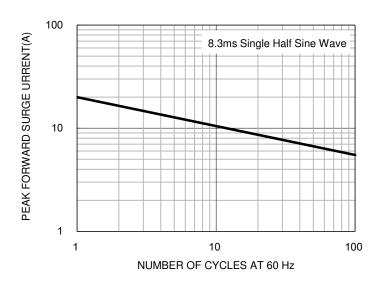
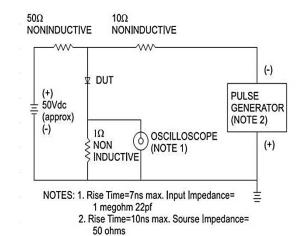
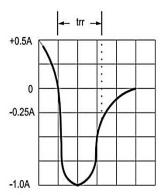


Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram

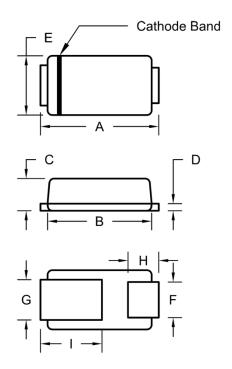






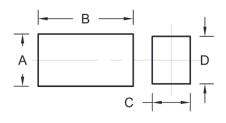
PACKAGE OUTLINE DIMENSIONS

Micro SMA



DIM	Unit	(mm)	Unit (inch)
DIN	Min.	Max.	Min.	Max.
Α	2.30	2.70	0.091	0.106
В	2.10	2.30	0.083	0.091
С	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	0.75	0.95	0.030	0.037
Н	0.55	0.75	0.022	0.030
I	1.10	1.50	0.043	0.059

SUGGESTED PAD LAYOUT

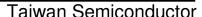


Symbol	Unit (mm)	Unit (inch)
Α	1.10	0.043
В	2.00	0.079
С	0.80	0.031
D	1.00	0.039

MARKING DIAGRAM



P/N = Marking Code ΥW = Date Code





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